

ESD Simulator for Electronics Parts

Reproduce ESD phenomena variably

- Simulator to reproduce electrostatic discharges (ESD) which are caused by a charged human body or machine designed with capacitor type and discharge the ESD to electronic devices for evaluating the resistibility against ESD.

In case the discharger is a human body, the test is called as Human Body Model (HBM) and in case it is a metallic object, the test is called as Machine Model (MM). This simulator is available to perform the both tests.

■ Target or potential customers

- Communication equipments (Mobile phone, mobile network devices, etc.)
- Materials (Plastic resin, film board, etc.)
- Electronic devices (Semiconductor, LED, crystal oscillator, SAW filter etc.)
- Others (Electric or electronic equipments demanded for EMC tests)

■ Test standards

- MIL-STD-883
- EIAJ ED-4701 etc.
- Individual industrial standards
- Private standards by manufacturers



* "Private standards by manufacturers" shall be discussed separately

ESS-6002 /6008

Feature

- Optimal for testing sensitive devices because of the output voltage from 10V (1V step)(ESS-6002).
- Enables to evaluate the robustness against the breakdown voltage with the output voltage up to 8kV (10V step).(ESS-6008)
- The direct discharge to the IC clip is available with the free board equipment
- Constant qualitative discharge is available with the semi-automatic operation (in Semi-Automatic Precision Type).
- Available both for Human Body Model (HBM) test and Machine Model (MM) test
- Enable to discharge standards waveforms in between terminals
- Characteristics variation of DUT can be verified with measurement terminal (The measurement equipment is necessary besides)
- Enable to set the faster rise-up (with an optional card)



Semi-automatic precision tyoe probe stand

Test Standard

Human Body Model (HBM)

AEC-Q100-002-Rev.D Jul.2003

ESDA ANSI/EOS/ESD-STM5.1-2001

IEC 61340-3-1Ed.1.0 2002

IEC 60749-26 Ed.1.0 2003

JEDEC JESD22- A114E Jan.2007

JEITA EIAJ ED-4701/300 Aug.2001 Test Method304

MIL-STD-883F 3015.7 Mar.1989

Machine Model (MM)

AEC-Q100-003-REV -E Jul.2003

ESDA ANSI/ ESD STM5.2-1999

IEC 61340-3-2 Ed.1.0-2002

IEC 60749-27 Ed.1.0 2003

JEDEC JESD22- A115A Oct.1997

JEITA EIAJ ED-4701/300 Aug.2001 Reference Test Method

Specification

Parameter	Specification
Output voltage	ESS-6002 10~2000V±10% (1V step) ESS-6008 100~8000V±10% (10V step)
Porality	Positive and negative
Repetition period	0.3~99s±10% 0.1s step to 10s, 1s step over 10s
EXT TRIG IN	±15V Max BNC coaxial connector Operation in TTL fall-down (LOW over than 100µs or short between terminals)
STAGE CONTROL	Control with pptional semi-automatic precision type probe stand (MODEL 18-00076A) Dsub connector
INTERLOCK	Stop test when open on the termial board or between terminals
Power supply	AC100~240V±10% 50Hz / 60Hz
Power consumption	25VA
Operating temperature range	15~35°C
Storage temperature range	-10~50°C
Operating humidity range	25~75%RH (without dew)
Storage temperature range	0~85%RH (without dew)
Dimension	(W) 340 X (H) 199 X (D) 300mm (Projecxtion excluded)
Mass	Approx. 6kg

Machine Model (MM) Probe 01-00055A

Parameter	Specification
Operating temperature / humidity range	15~35°C / 25~75%RH (without dew)
Dimension / Mass	(W) 50 X (H) 242 X (D) 54mm / Approx. 760g
CR	C : 200pF±10% R : 0Ω

Output waveform at short

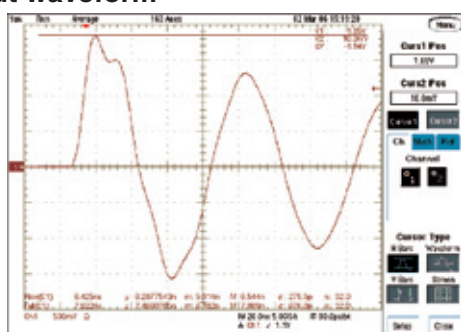
Voltage	1st peak current Ip 1	2nd peak current Ip 2	Cycle	Ringing Irs
100V	1.75A±10%			
200V	Min : 3.5A -10% Max.: 3.8Z	Min : 67% of Ip 1	Min : 66ns	≤30% of Ip 1
400V	7.5A±10%	Max : 90% of Ip 2	Max : 90nx	
800V	14A±10%			

Output waveform at 500Ω(±1%) load

Voltage	Peak current Ipr	Current at 100ns 1100nx	Current at 200ns 1200ns
100V	—	—	—
200V	—	—	—
400V	Min : 0.85A Max : 1.1745A	0.29A±10%	Min : 35% of 100ns Max : 45% of 100ns
800V	—	—	—

* Output voltage depends on capbiities of the simulator (ESS-6002 / 6008)

Output waveform



MM PROBE

Human Body Model (HBM) Probe 01-00054A

Parameter	Specification
Operating temperature / humidity range	15~35°C / 25~75%RH (without dew)
Dimension / Mass	(W) 50 X (H) 242 X (D) 54mm / Approx. 760g.
CR	C : 100pF±10% R : 1.5kΩ±1%

Output waveform at short

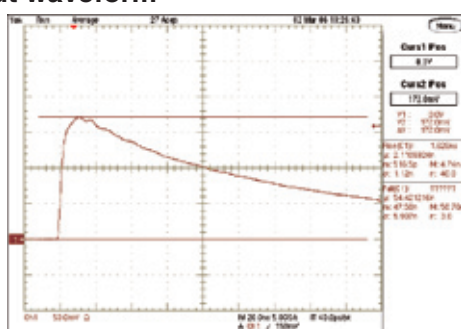
Voltage	Peak current Ips	Rise time Trs	Fall down time Tds	Ringing Irs
250V	0.17A±10%			
500V	0.33A ±10%			
1000V	0.67A±10%	Min : 2ns	Min : 1.3ns	<15% of Ips
2000V	1.33A±10%	Max : 10ns	Max : 1.7nx	
4000V	2.67A±10%			
8000V	5.33A±10%			

Output waveform at 500Ω(±1%) load

Voltage	Peak current Ipr	Ipr/Ips	Rse time Trs	Fall down time Tds	Ringing Irs
250V	—	—	—	—	—
500V	min : 60% of Ips max : 0.25A-25%	≥63%	5~25ns	200ns±40ns	≤15%
1000V	min : 60% of Ips max : 0.5A-25%	≥63%	5~25ns	200ns±40ns	≤15%
2000V	min : 60% of Ips max : 1.0A-25%	≥63%	5~25ns	200ns±40ns	≤15%
4000V	min : 60% of Ips max : 2.0A-25%	≥63%	5~25ns	200ns±40ns	≤15%
8000V	—	—	—	—	—

* Output voltage depends on capbiities of the simulator (ESS-6002 / 6008)

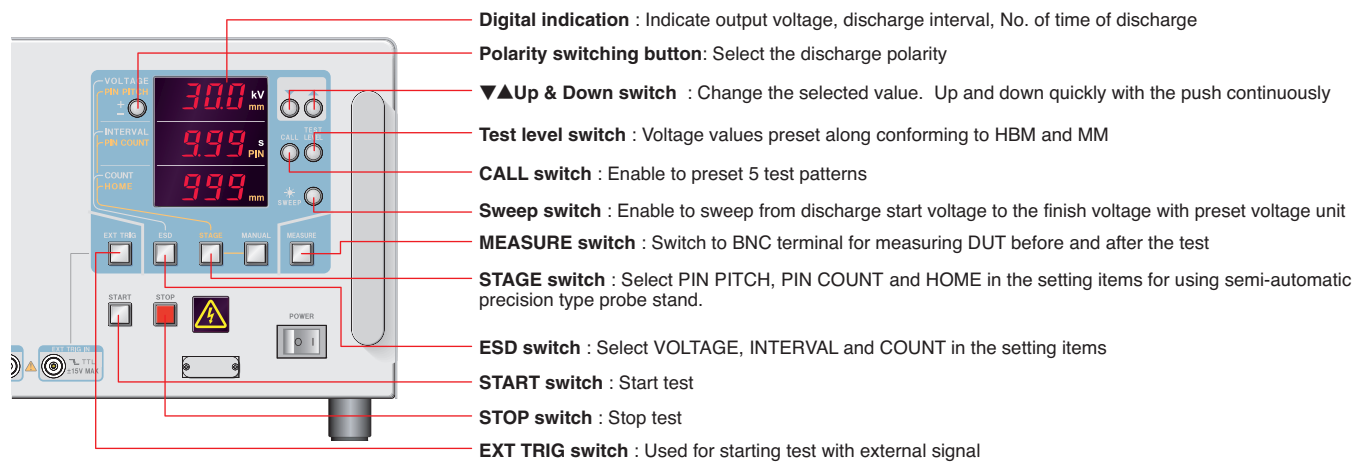
Output waveform



HBM PROBE

Front Panel

Simple usability



Accessory

Item	Q'ty
Human Body models (HBM) discharge probes (MODEL 01-00054A)	1 set
Machines Model (MM) discharge probes (MODEL 01-00055A)	1 set
(Attached with 2 pcs. of waveform adjustment card MODEL 06-00065A)	
AC code	1 pc.
Instruction manual	1 volume

Free Type Probe Stand 18-00075A

Parameter	Specification
Dimension / Mass (probes stand unit)	(W) 200x(H)330x(D)290 mm / Approx. 1.5kg
Dimension / Mass (free board)	(W) 100x(H)27x(D)180 mm (Projection excluded) / Approx. 200g
Vise gap	110 mm
Others	V-shape block included



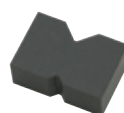
Probes stand uni



Discharge clips
(Black and red colored X 2)



Free board



V-shape block



Figure the probe connected

Discharging figures



When free type probe stand 18-00075A is used

Noise is discharged from the IC clip attached with the probe stand to devices which are fixed using the free board or the V-shape block

Semi-Automatic Precision Type Probe Stand **18-00076A**

Easy test to semiconductors whose pitches are mm or inch since the minimum resolution accuracy is 0.01mm.

- The stage moves automatically accompanied by the discharge.
- Easy removal and attachment of the probe.
- Available for easy measurement with a measurement equipment after the discharge since the probe can be fixed at the discharge.

Item	Specification
Dimension / Mass	(W) 250x(H)400x(D) 300 mm / Approx 7 kg
Applicable IC size	Maximum size : 40 mm X 40mm Minimum lead pitch : 0.4 mm
X-Y-θ table	
X axis	Manual movement : 20mm with dovetail groove feed screw mechanism
Y- axis	Motor drive (Maximum velocity : 13 mm/s) Movement : 40 mm (Y resolution : 0.01mm) * Stepping motor & ball screw
θ axis	Manual movement: 360°
Z-axis	Manual movement : 20mm (A spring built-in)
Origin adjustment	Manual



Main unit



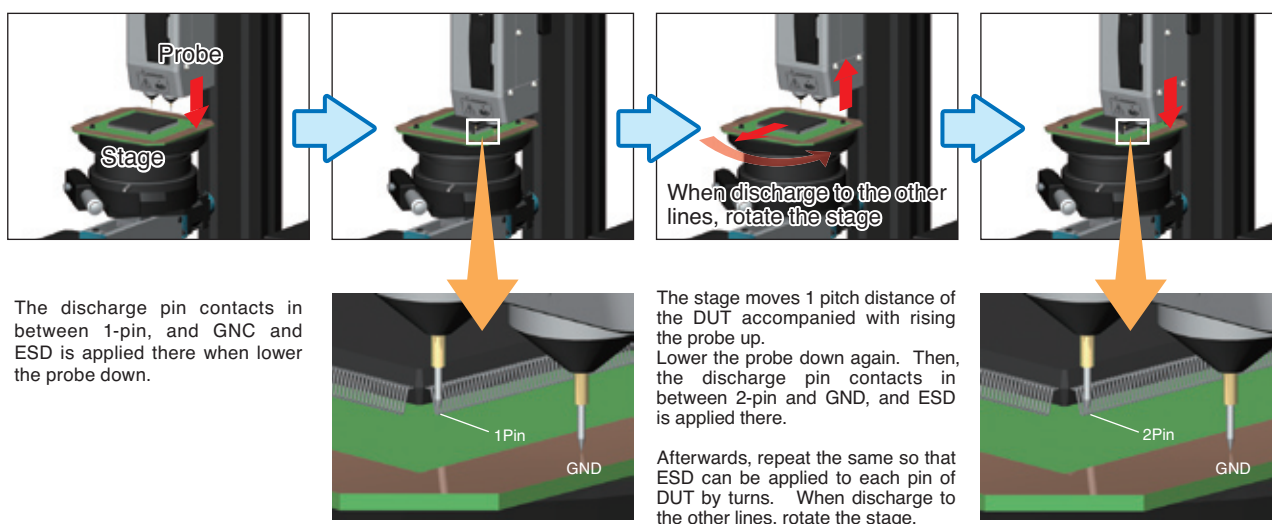
Discharge pin 20 pcs.

GNC clip 2 pcs.

Control cable
for connection to main unitFG connection cable
for connection to main unit

Figure the probe attached

Application example



Waveform Adjustment Card (4 pcs. in 1 set) **MODEL : 06-00064A**



For changing rise up time or cycle of the waveform
(Not specified in Standards)

Human Body models (HBM) probe	Machines models (MM) probe
HBM-F card for HBM (Fast)	MM-HF card for MM (High Frequency)
Rise-up time : 2~4ns (typical)	Cycle : 69~75ns (typical)
HBM-S card for HBM (Slow)	MM-LF card for MM (Low Frequency)
Rise-up time : 6~8ns (typical)	Cycle : 83~89ns (typical)

Discharge Clip 2.54mm pitch type **MODEL : 08-00013A**



Discharge clip
2.54mm pitch type
MODEL : 08-00013A
Red colored 2 pcs.
Black colored 2 pcs.

Discharge Clip 0.3mm pitch type **MODEL : 08-00014A**



Discharge clip
0.3mm pitch type
MODEL : 08-00014A
Red colored 2 pcs.
Black colored 2 pcs.

Option for Free Type Probe Stand : Dust-Protection case **MODEL : 11-00012A**



Option for Semi-Automatic Precision Type Probe Stand : Dust-Protection case **MODEL : 11-00013A**





– Memo –